



Dopant profiles of p+ regions in Si wafers with photoluminescence at room temperature

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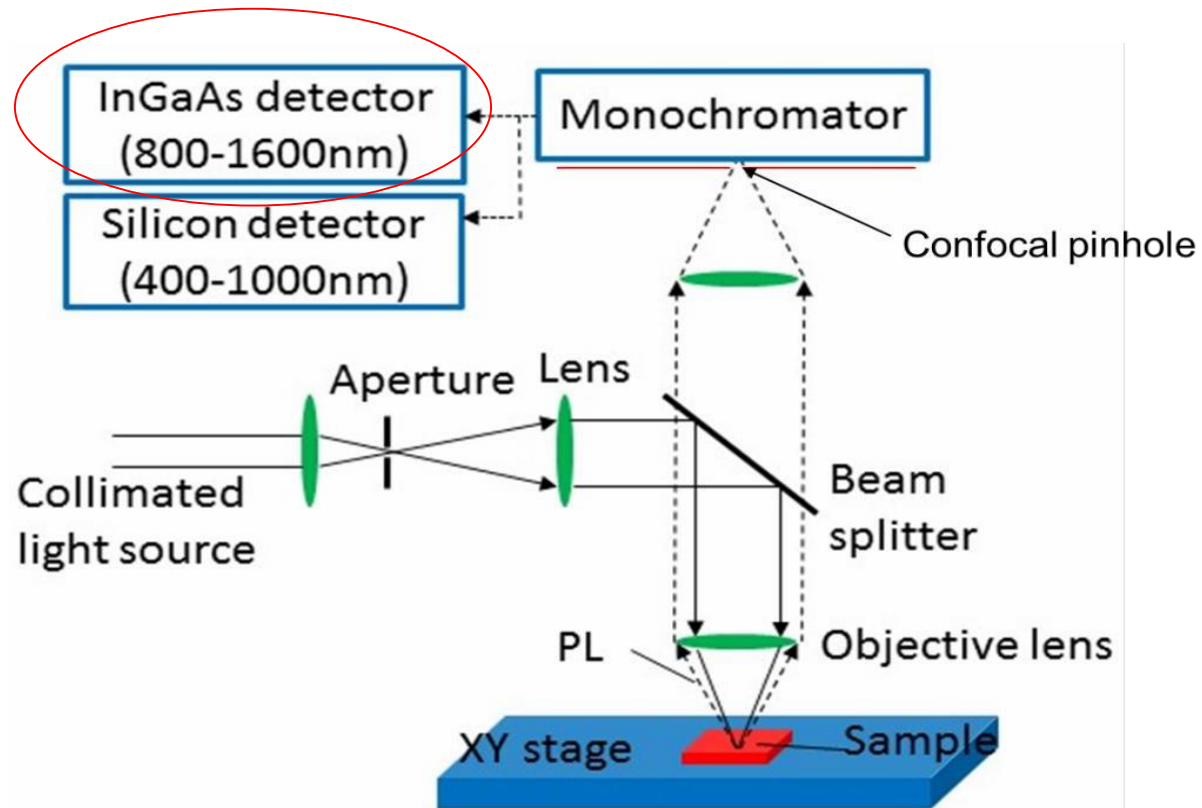
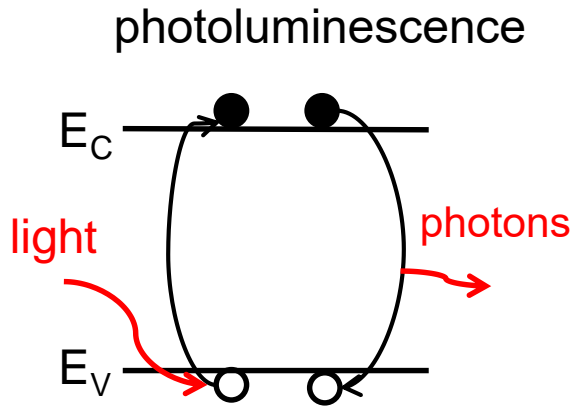
Traditional methods of determining dopant profiles of c-Si

1. ECV (No spatial resolution, destructive)
2. SIMS (Expensive, destructive and slow)

Photoluminescence measurements at room temperature

1. Fast
2. Contactless
3. Non-destructive
4. High spatial resolution (micron scale)

Micro-photoluminescence at room temperature



PL spectrum \rightarrow dopant profiles

Calibration Samples

- Heavily boron diffused
- Dopant profiles measured with ECV technique

Micro-PL Setup

- 500 nm and 600 nm of excitation wavelengths
- ~1 μm of illumination spot size
- 1.5 mW of on-sample power
- 50x objective lens (numerical aperture of 0.55)

Gaussian fitting function

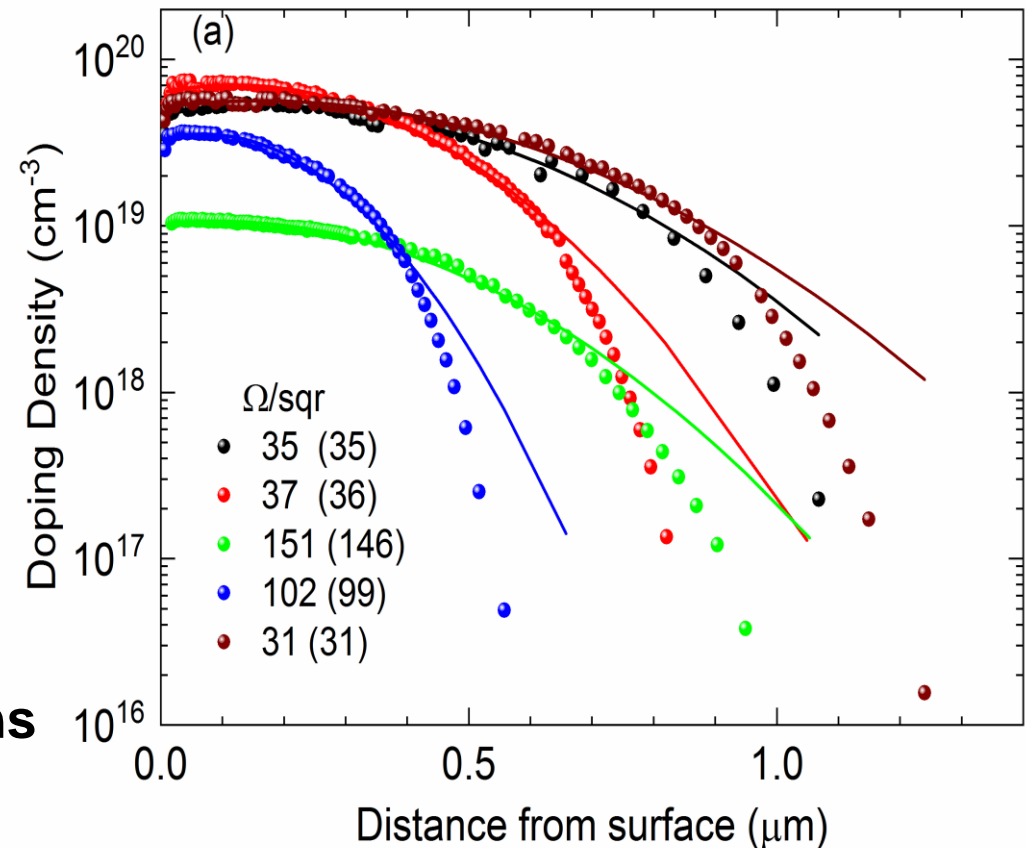
$$N(Z) = N_p \times \exp\left[-\frac{(Z - Z_p)^2}{Z_f^2}\right]$$

1. Peak dopant density: N_p
2. Depth factor: Z_f
3. Depth where peak dopant density occurs: Z_p

Parameters \rightarrow Dopant profiles

Extract N_p , Z_f , Z_p for calibrations

ECV profiles of calibration samples

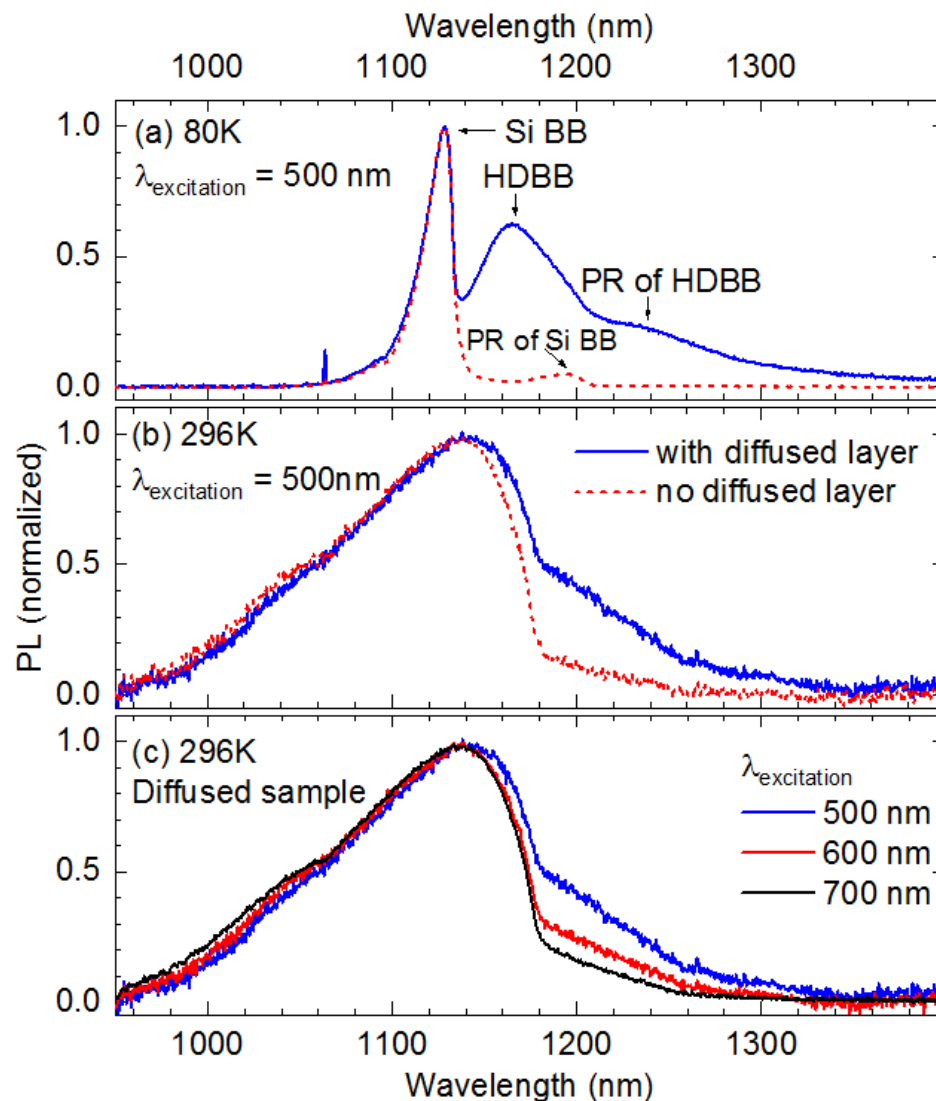


Principles

At 80 K, two peaks occur due to the diffused layer and the c-Si substrate

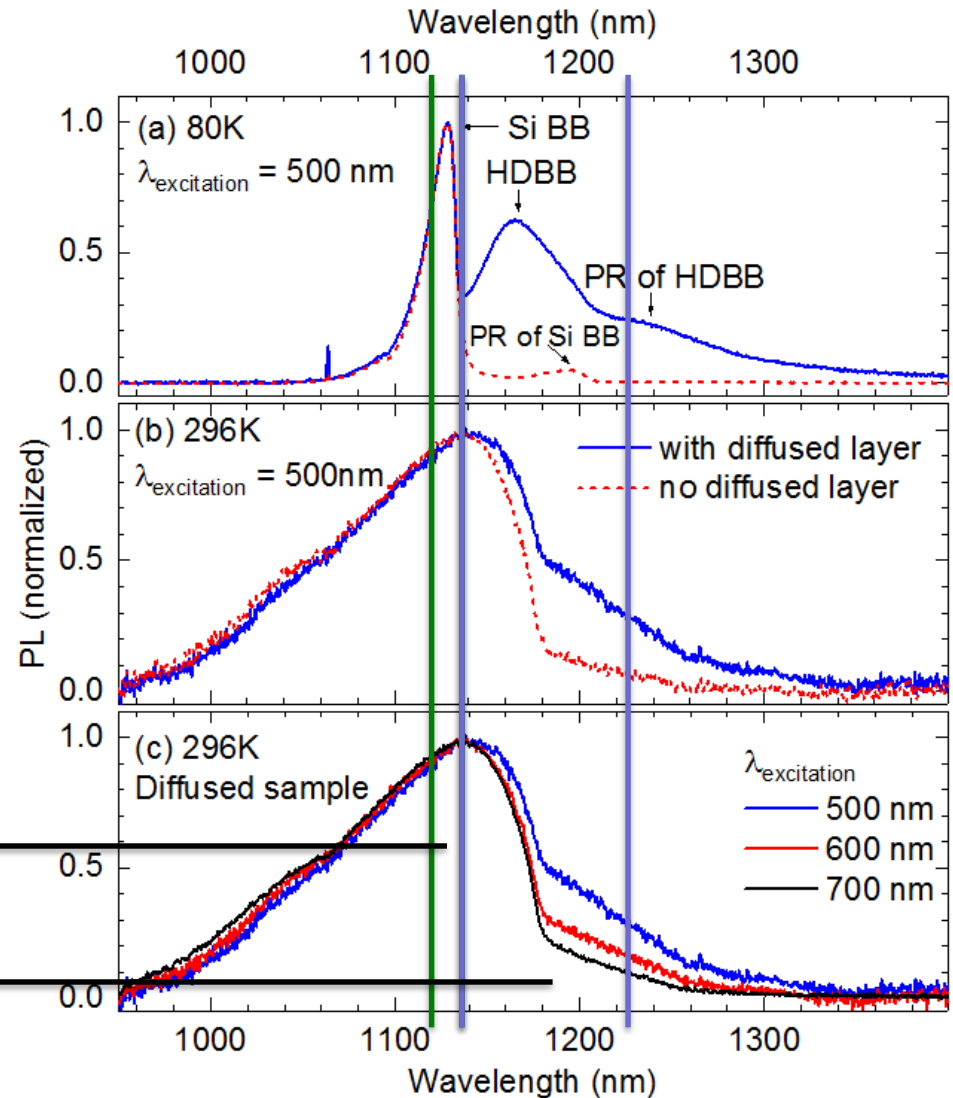
Indistinguishable peaks at room temperature

As the excitation wavelength increases, the PL intensity decreases



PL ratio

Take the ratio between integrated PL intensities of **1135–1250 nm** (diffused layer) and **1115–1135 nm** (silicon substrate)

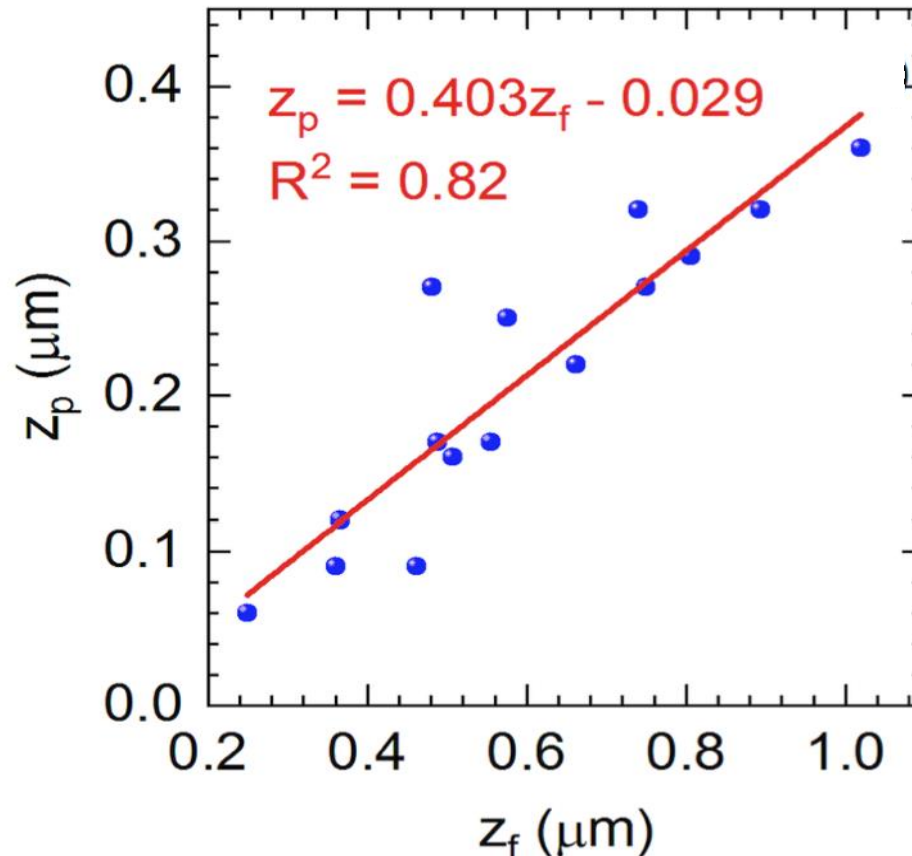


1115 – 1135 nm ←

1135 – 1250 nm ←

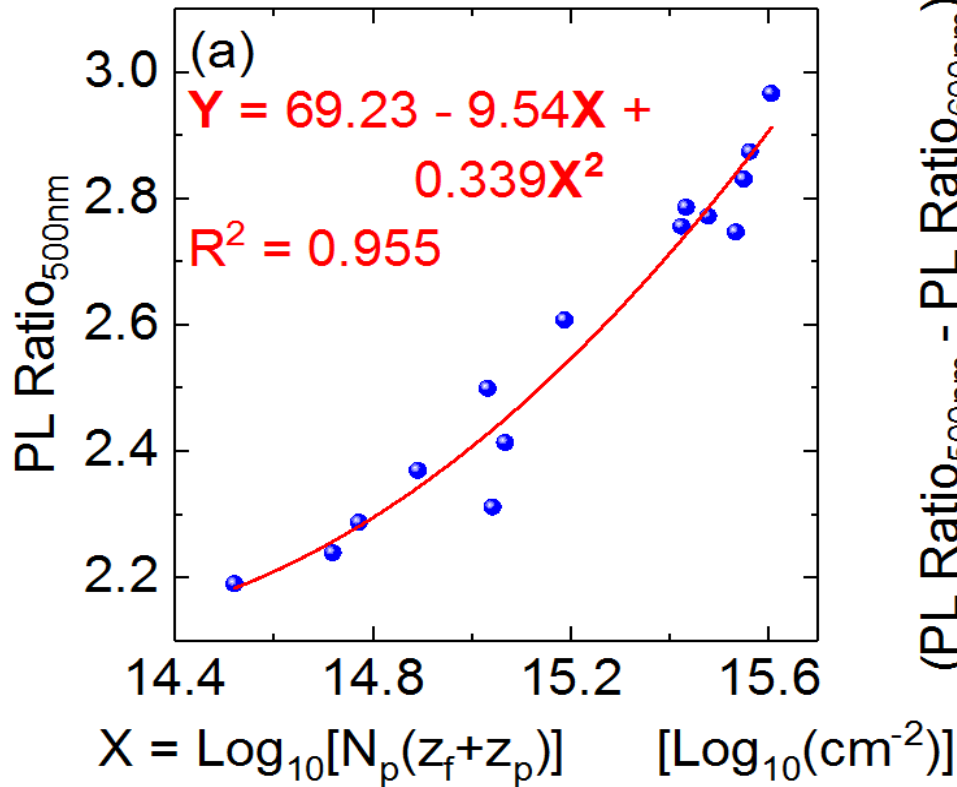
Z_p vs Z_f

Inherently correlate because the deeper the peak dopant density is, the more dopant atoms diffuse into the silicon substrate.

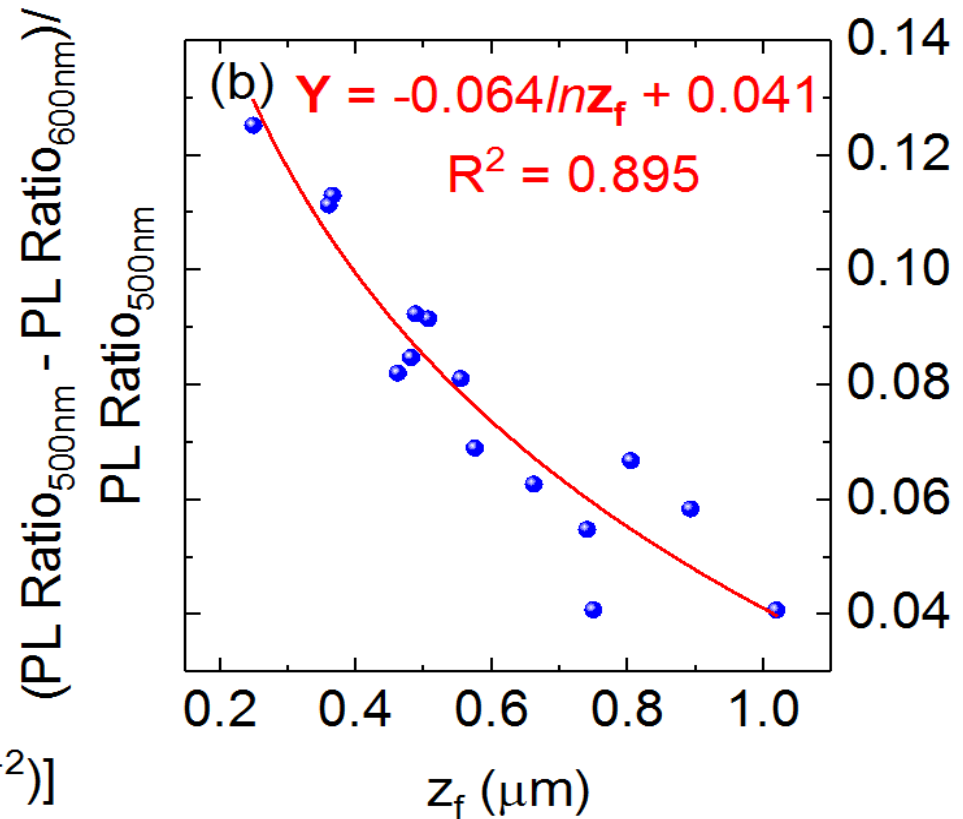


Correlations (2/2)

{N_p, Z_f, Z_p} vs PL ratio
at λ excitation of 500 nm



Z_f vs PL ratio change between
λ excitation of 500 nm and 600 nm

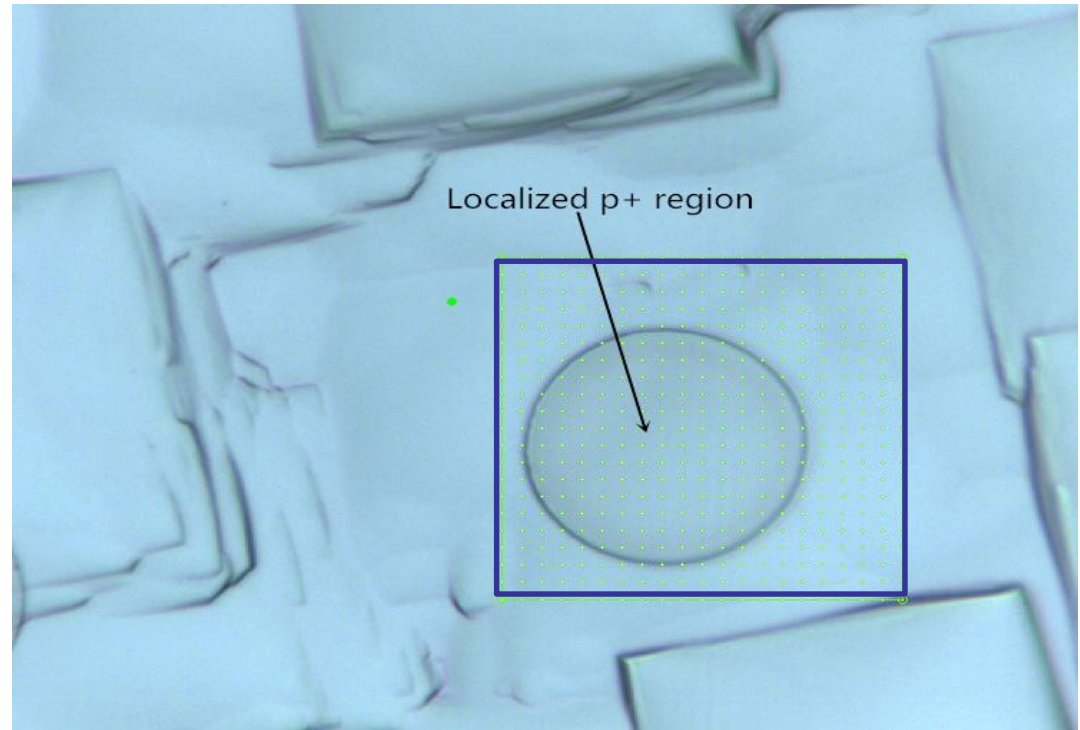


Methodology

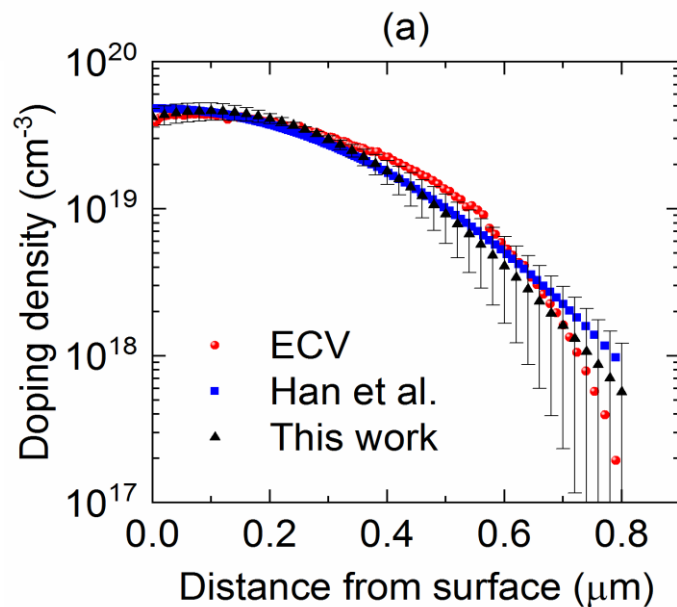
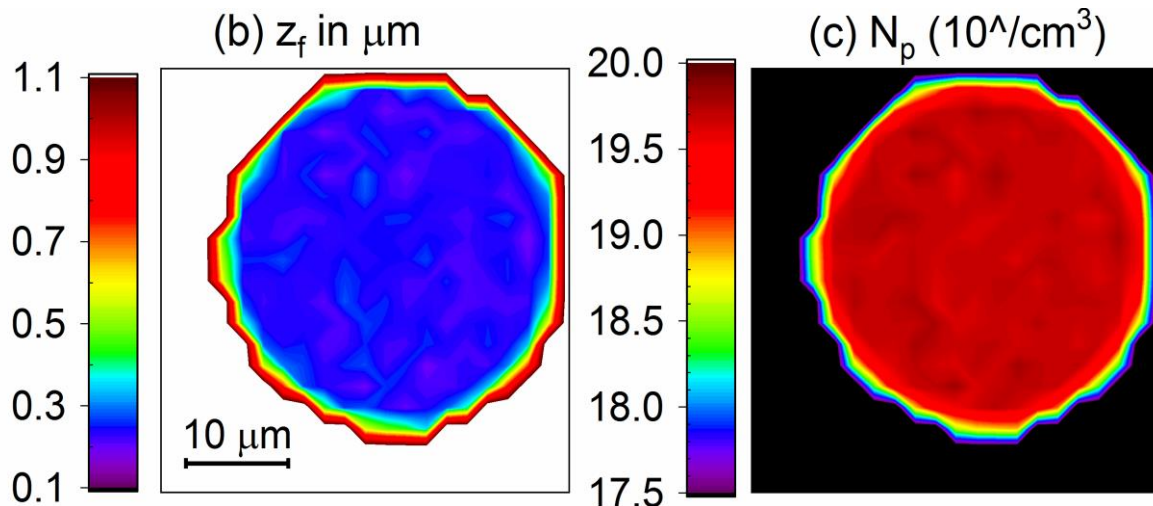
Micro-PL mapping

Sample

PERL solar cell
precursor with
localized diffused
regions (30 μm in
diameter)



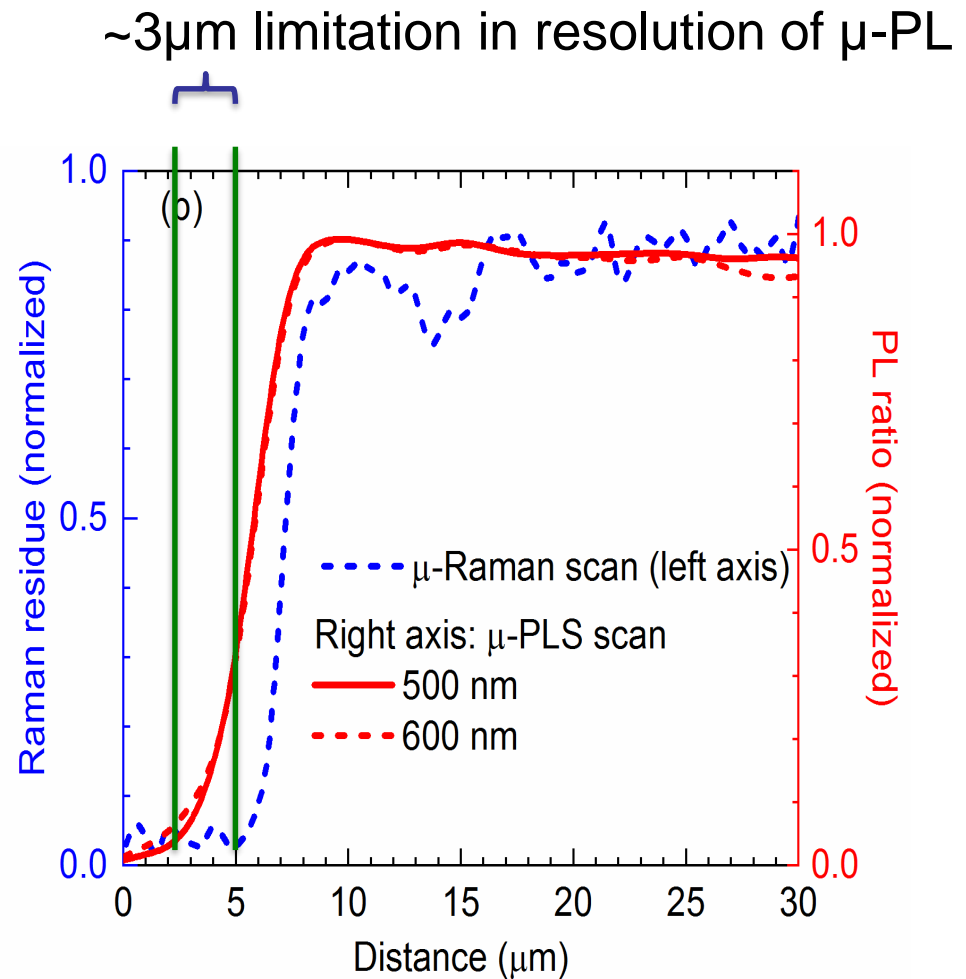
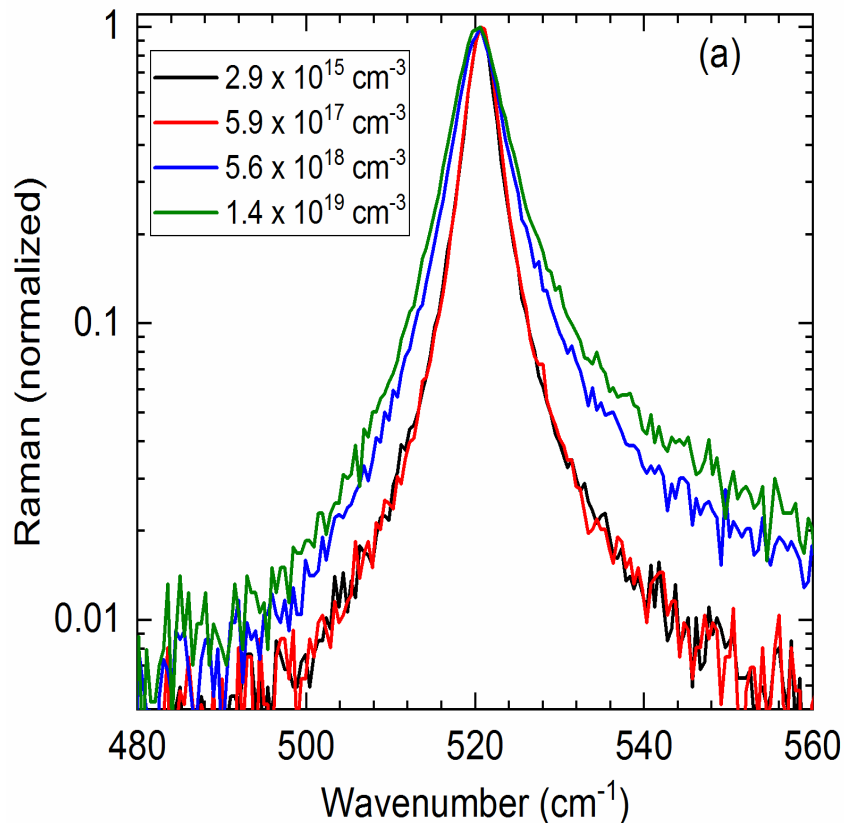
Reconstructing dopant profiles (2/3)



The reconstructed dopant profile agrees with the ECV profile

Micro-Raman mapping

Higher dopant density
 → Broader Raman spectrum peak





Micro-PL at room temperature (296 K)

- Fast
- Contactless
- Non-destructive
- High spatial resolution



Acknowledgment

ARENA



Australian Government
Australian Renewable
Energy Agency



ACAP

Australian Centre for
Advanced Photovoltaics



ANFF

Australian National
Fabrication Facilities



Q & A

SIMS: secondary ion mass spectroscopy

- Dynamics: 100x micron, sensitivity = 10x higher than ToF SIMS
- Time of Flight (ToF): sub-micron (100x nano)

ECV: electrochemical capacitance-voltage

- Spot size: 4-5 mm in diameter
- Control sample measurement

Fabrication of calibration samples

Float zone 100 Ω .cm n-type silicon wafer

Diffusion steps:

1. Quartz tube-furnace deposition step
2. Wet-chemical etching
3. High-temperature drive-in step

PL Setup

Spectral correction for PL: Halogen light source

Supercontinuum NKT laser source (480 – 2000nm)

Raman Setup

CCD Si array detector (400 – 1000nm)

Solid-state 532-nm laser

PERL solar cell: passivated-emitter rear
localized diffused solar cell (fabricated from a
FZ 5 Ω .cm p-type Si wafer)

PERC: passivated-emitter rear contact

IBC: interdigitated back contact